

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Cheng Lin</td><td>02/06/2007</td></tr><tr><td>Nurulhuda Binte Jumahri</td><td>02/06/2007</td></tr></tbody></table>	Name	Execution Date	Cheng Lin	02/06/2007	Nurulhuda Binte Jumahri	02/06/2007							
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RECEIVING PARTY DATA													
<table border="1"><tr><td>Name:</td><td>TECH Semiconductor Singapore Pte Ltd</td></tr><tr><td>Street Address:</td><td>No. 1 Woodlands Industrial Park D</td></tr><tr><td>Internal Address:</td><td>Street 1</td></tr><tr><td>City:</td><td>Singapore</td></tr><tr><td>State/Country:</td><td>SINGAPORE</td></tr><tr><td>Postal Code:</td><td>738799</td></tr></table>	Name:	TECH Semiconductor Singapore Pte Ltd	Street Address:	No. 1 Woodlands Industrial Park D	Internal Address:	Street 1	City:	Singapore	State/Country:	SINGAPORE	Postal Code:	738799	
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PROPERTY NUMBERS Total: 1													
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CORRESPONDENCE DATA													
Fax Number: (845)471-2064 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>													
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ATTORNEY DOCKET NUMBER:	TE06-004												
NAME OF SUBMITTER:	Stephen B Ackerman												
Total Attachments: 2 source=TE06-004#page1.tif source=TE06-004#page2.tif													

CH \$40.00 11705636

PATENT

500257307

REEL: 019151 FRAME: 0275

TE06-004

For ☒ U.S. and/or ☒ Foreign Rights
For ☒ Application or ☐ U.S. Patent
By ☒ Inventor(s) or ☐ Present Owner

ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration,

ASSIGNOR:

CHENG LIN
Type or print name of ASSIGNOR

Westcoast Crescent Westbay Condo, #03 01
Address

Singapore 128040

Chinese
Nationality

NURULHUDA BINTE JUMAHRI
Type or print name of ASSIGNOR

BLK 308 Choa Chu Kang Avenue 4, #02-709
Address

Singapore 680308

Singapore
Nationality

hereby sells, assigns and transfers to

ASSIGNEE:

TECH Semiconductor Singapore Pte Ltd
No. 1 Woodlands Industrial Park D
Street 1
Singapore 738799
Singapore
Nationality

and the successors, assigns and legal representatives of the ASSIGNEE

(complete one of the following)

☒ the entire right, title and interest

☐ an undivided _____ percent (____%) interest for the United States and its territorial

possessions

(check the following box if foreign rights are also to be assigned)

☒ and in all foreign countries

in and to any and all improvements which are disclosed in the invention entitled:

Method And System For Wafer Lot Order

and which is found in

- ☒ (a) U.S. patent application executed on even date herewith
☐ (b) U.S. patent application executed on _____
☐ (c) U.S. application serial no. _____ filed on _____
☐ (d) U.S. patent no. _____ issued _____
(also check (e) if foreign application(s) is also being assigned)
☒ (e) and any legal equivalent thereof in a foreign country, including the right to claim priority

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuation, division, renewal, or substitute, thereof, and as to letters patent any re-issue or re-examination thereof.

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

IN WITNESS WHEREOF, I / We have signed this

06 FEB 2007 (Date of signing)

WARNING Date of signing must be the same as the date of execution of the application if item (a) was checked above.

[Signature] (CHENG LIN)
Signature of ASSIGNOR(S)
[Signature] (NURULHUDA BINTE JUMAHRI)

If ASSIGNOR is a legal entity complete the following information

Type or print the name of the above person authorized
to sign on behalf of ASSIGNOR

Title

Note: No witnessing, notarization or legalization is necessary, if the assignment is notarized or legalized then it will only be prima facie evidence (35 USC 261). Use next page if notarization is desired.

Notarization of Legalization Page Added.